

PCN Number:	20180724000	PCN Date:	July 25, 2018
Title:	Datasheet for LM2903-Q1		
Customer Contact:	PCN Manager	Dept:	Quality Services
Change Type:			
☐ Assembly Site	☐ Design	☐ Wafer Bump Site	
☐ Assembly Process	☒ Data Sheet	☐ Wafer Bump Material	
☐ Assembly Materials	☐ Part number change	☐ Wafer Bump Process	
☐ Mechanical Specification	☐ Test Site	☐ Wafer Fab Site	
☐ Packing/Shipping/Labeling	☐ Test Process	☐ Wafer Fab Materials	
		☐ Wafer Fab Process	

Notification Details

Description of Change:

Texas Instruments Incorporated is announcing an information only notification.
The product datasheet(s) is being updated as summarized below.
The following change history provides further details.



LM2903-Q1

SLCS141F – MAY 2003 – REVISED MAY 2018

Changes from Revision E (June 2014) to Revision F

Page

- | | |
|---|---|
| • Added LM2903E-Q1 to datasheet..... | 1 |
| • Changed Thermal Information Table | 4 |

The datasheet number will be changing.

Device Family	Change From:	Change To:
LM2903-Q1	SLCS141E	SLCS141F

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/LM2903-Q1>

Reason for Change:

To accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

Changes to product identification resulting from this PCN:

None.

Product Affected:

LM2903AVQDRG4Q1	LM2903EPWRQ1	LM2903QPWRG4Q1	LM2903VQPWRG4Q1
LM2903AVQDRQ1	LM2903QDGKRQ1	LM2903QPWRQ1	LM2903VQPWRQ1
LM2903AVQPWRG4Q1	LM2903QDRG4Q1	LM2903VQDRG4Q1	PLM2903EPWRQ1
LM2903AVQPWRQ1	LM2903QDRQ1	LM2903VQDRQ1	

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com